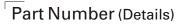
Specifications

Insulation Resistance:1,000Mmin. at 100V DCDielectric Withstanding Voltage:100V AC for 1 minuteContact Resistance:30mmax. at 10mA/20mOperating Temperature Range:-55°C to +150°C

Contact Force: Operationg Force: Mating Cycles: e: 100V AC for 1 minute 30m max. at 10mA/20mV max. : -55°C to +150°C -40°C to +170°C 13g per pin approx. 3.2 Kg 10,000 insetions







Features

Open top type sockets for BGA packages
Coverless shrink version
2-point Tweezer Contact System

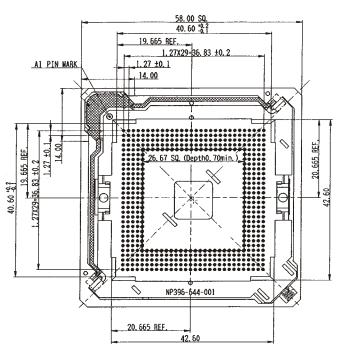
Plating: Gold over Nickel

Materials and Finish

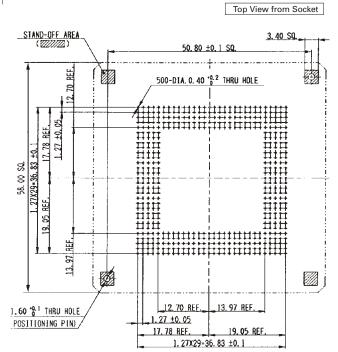
Housing: Polyetherimide (PEI), glass-filled

Contacts: Beryllium Copper (BeCu)

Outline Dimensions



Recommended PC Board Layout



Recommended PC Board Layout

SOCKET CENTER

PKG CENTER

635

